HOW AR, EDGE AI AND ADVANCED MEMS ENABLE BREATHTAKING NEW APPLICATIONS





Next-level MEMS and Microsystem Technology Application: Smart AR Glasses and Smart MEMS



- ► All-day smart / AR glasses are the next big thing ("the new Smartphone")
- ► Key will be to achieve low weight ("magic 40 gramm") & excellent picture quality for smart glasses
- Advanced positioning by using smart & high performance MEMS sensors enriched by embedded AI
- Technology needs to evolve significantly to fulfil the challenging requirements



Huge market upcoming

Digital assistant Increase quality of life Hands-free support Efficiency Assistant for all ages Working Many use cases for all people



Attractive & minimal ... design, design, design



Comfortable & lightweight

... and a natural display in line of sight



Bright & transparent

... and glare-free at night



Precise & fast localization

.... continuous self-improvement by AI

Requirements not solved so far

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Next-level MEMS and Microsystem Technology Challenges

A great user experience of the overall smart optical system can be achieved by

- ► low weight & high picture quality using highly miniaturized optical components (Display, MEMS projector)
- ► best-in-class MEMS sensors (e.g. IMU = Inertial Measurement Unit) w. ultra-high performance/robustness
- ▶ optimized embedded Software/AI and algorithms for HMI, visualization, picture stabilization and localization

Need for ultra-compact, light-weight and high performance MEMS systems



All aspects need to come together

- New high performance and lightweight MEMS components
- Low weight and robust packaging concepts
- Low power laser diodes
- Efficient micro-optics assembly technology
- Seamless Audio-Video integration
- Sensor fusion to enable AR by eye-tracking, head-tracking and camera-free orientation

Sensing is key to move from display glasses to augmented reality



Now it is the time to bring Europe in the pole position

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High-performance inertial sensors Application: Highly automated driving HAD

AUTOMATED

- Localization based on satellite and sensor data fusion Cam, USS, Radar, Lidar
- Secure safe-stop requires relative short-term localization with high precision
- Localization can be realized with high-performance inertial sensors
- Key features for inertial navigation: high offset stability and low noise





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High-performance inertial sensors Challenges

- On the path from "level 0" to truly autonomous driving ("level 4/5") we need to improve the performance of inertial sensors by orders of magnitude:
- ▶ Improvement factors for bias stability: ×50 100, noise: ×10 30, offset: ×20 40



Localization needs to be safe, precise, and available on highways and in cities, for all driving and weather situations. Safe Stop requires high performance sensors – otherwise the car leaves its lane.



AUTOMATED



Multifunctional Integration Summary

- Advanced functional innovation of complex systems requires multifunctional integration of technologies and components
- Europe's strength in complex systems is based on smart combination of dedicated technologies generating sustainable USP
- Continued high innovation speed possible and needed



Technologies, manufacturing and integration processes

